

# **2SK1808** Silicon N Channel MOS FET

REJ03G0975-0200 (Previous: ADE-208-1322) Rev.2.00 Sep 07, 2005

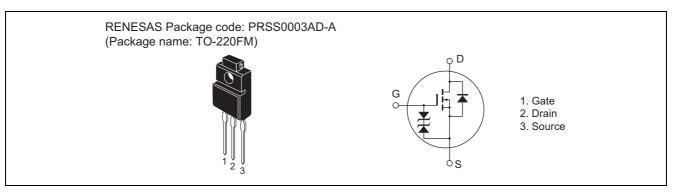
### Application

High speed power switching

### Features

- Low on-resistance
- High speed switching
- Low drive current
- No secondary breakdown
- Suitable for switching regulator, DC-DC converter

### Outline





# **Absolute Maximum Ratings**

			$(1a = 25^{\circ}C)$
ltem	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DSS</sub>	900	V
Gate to source voltage	V <sub>GSS</sub>	±30	V
Drain current	ID	4	А
Drain peak current	I <sub>D(pulse)</sub> *1	10	А
Body to drain diode reverse drain current	I <sub>DR</sub>	4	А
Channel dissipation	Pch <sup>*2</sup>	35	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW  $\leq$ 10  $\mu$ s, duty cycle  $\leq$  1 %

2. Value at  $Tc = 25^{\circ}C$ 

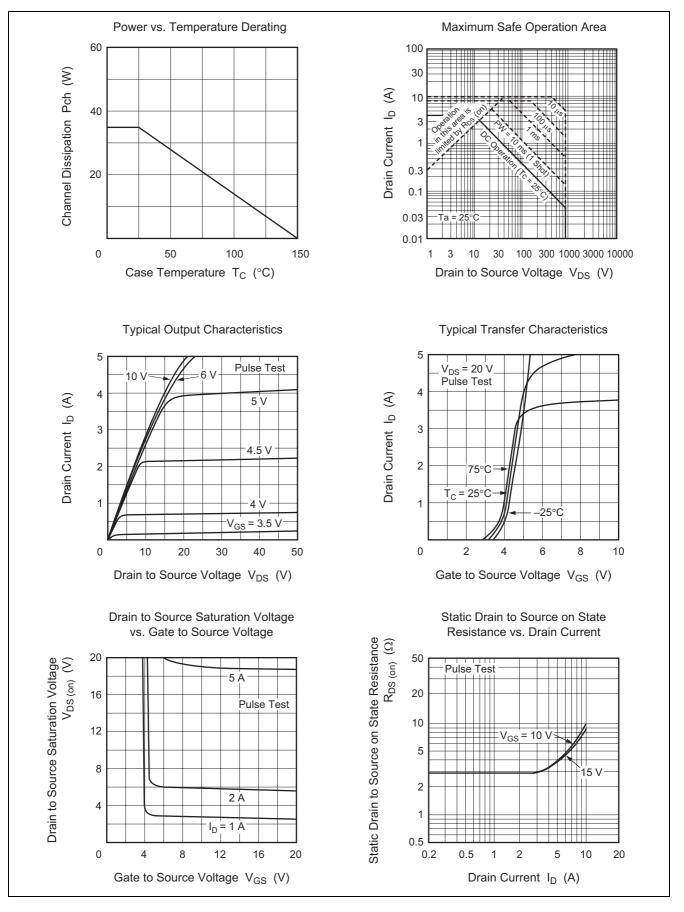
# **Electrical Characteristics**

						$(Ta = 25^{\circ}C)$
ltem	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V <sub>(BR)DSS</sub>	900	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V <sub>(BR)GSS</sub>	±30	_	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I <sub>GSS</sub>	_	_	±10	μA	$V_{GS} = \pm 25 \text{ V},  V_{DS} = 0$
Zero gate voltage drain current	I <sub>DSS</sub>	_	—	250	μA	$V_{DS} = 720 V, V_{GS} = 0$
Gate to source cutoff voltage	V <sub>GS(off)</sub>	2.0	_	3.0	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static drain to source on state	R <sub>DS(on)</sub>		3.0	4.0	Ω	$I_D = 2 \text{ A}, V_{GS} = 10 \text{ V}^{*3}$
resistance						
Forward transfer admittance	y <sub>fs</sub>	1.7	2.7	—	S	$I_D = 2 A, V_{DS} = 20 V^{*3}$
Input capacitance	Ciss	_	740	—	pF	$V_{DS} = 10 V, V_{GS} = 0,$
Output capacitance	Coss	—	305	—	pF	f = 1 MHz
Reverse transfer capacitance	Crss	_	150	—	pF	
Turn-on delay time	t <sub>d(on)</sub>	_	15	—	ns	$I_D = 2 \text{ A}, V_{GS} = 10 \text{ V},$
Rise time	tr	_	60	_	ns	R <sub>L</sub> = 15 Ω
Turn-off delay time	t <sub>d(off)</sub>		100	_	ns	
Fall time	t <sub>f</sub>	_	80	_	ns	
Body to drain diode forward voltage	V <sub>DF</sub>		0.9	_	V	$I_F = 4 \text{ A}, V_{GS} = 0$
Body to drain diode reverse	t <sub>rr</sub>		800	_	ns	$I_F = 4 \text{ A}, V_{GS} = 0,$
recovery time						di <sub>F</sub> /dt = 100 A/µs

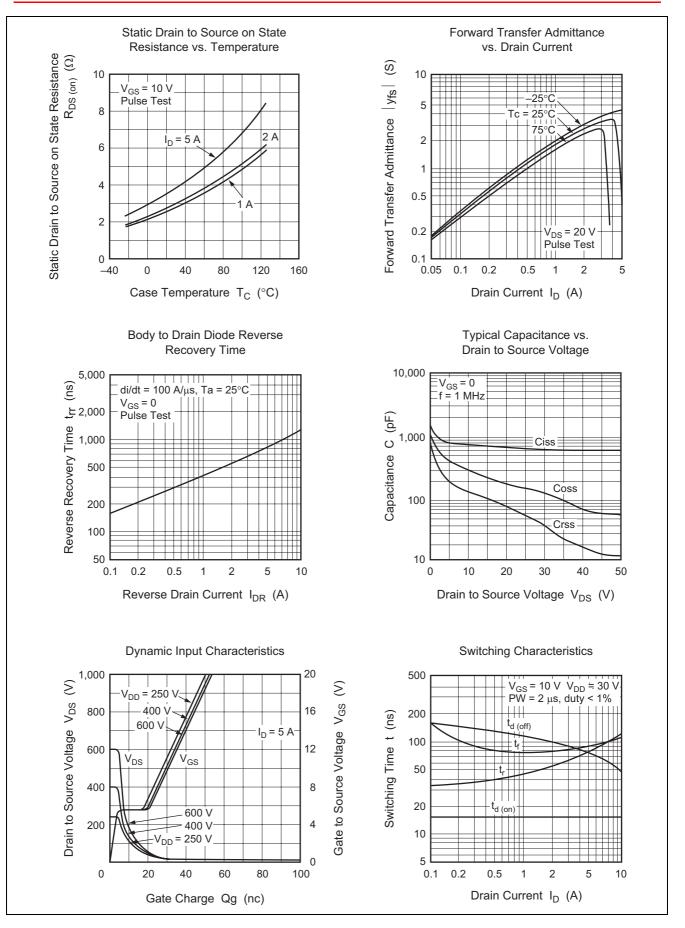
Note: 1. Pulse Test



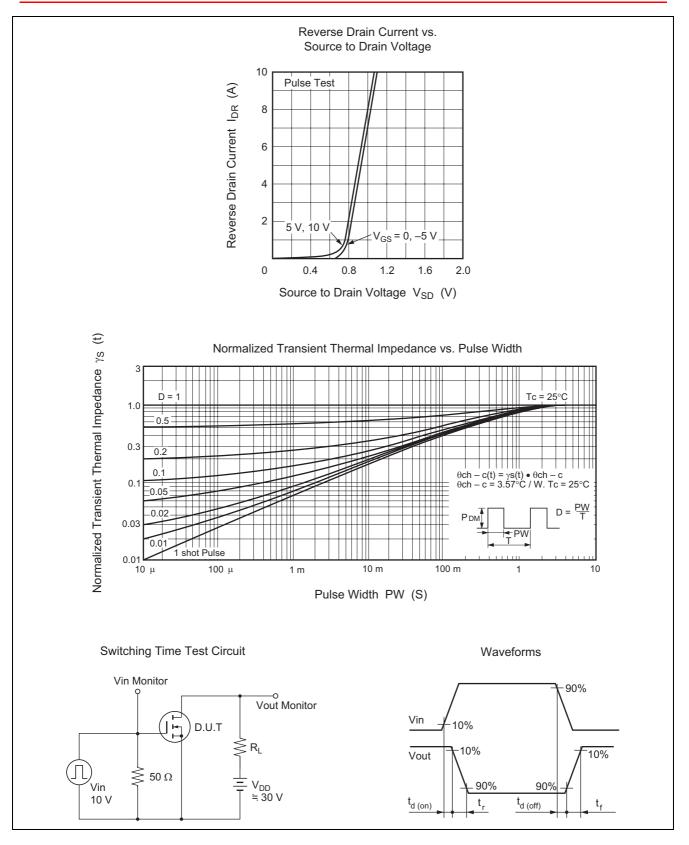
### **Main Characteristics**





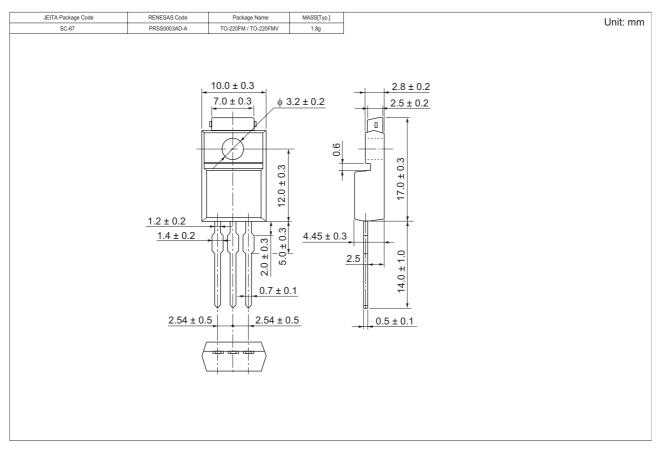






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# Package Dimensions



### **Ordering Information**

Part Name	Quantity	Shipping Container
2SK1808-E	500 pcs	Box (Sack)

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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